2SC1509

Silicon NPN epitaxial planer type

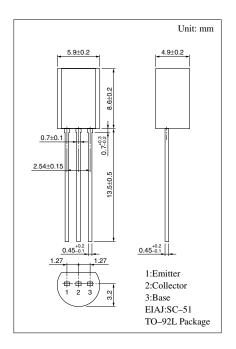
For low-frequency driver amplification Complementary to 2SA0777 (2SA777)

Features

- High collector to emitter voltage V_{CEO}.
- Optimum for the driver stage of a low-frequency and 25 to 30W output amplifier.

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	80	V
Collector to emitter voltage	V_{CEO}	80	V
Emitter to base voltage	V_{EBO}	5	V
Peak collector current	I_{CP}	1	A
Collector current	I_{C}	0.5	A
Collector power dissipation	P_{C}	1	W
Junction temperature	T_{j}	150	°C
Storage temperature	T_{stg}	−55 ~ +150	°C



Electrical Characteristics (Ta=25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = 20V, I_{E} = 0$			0.1	μА
Collector to base voltage	V _{CBO}	$I_{\rm C} = 10\mu{\rm A}, I_{\rm E} = 0$	80			V
Collector to emitter voltage	V _{CEO}	$I_{\rm C} = 100 \mu {\rm A}, I_{\rm B} = 0$	80			V
Emitter to base voltage	V _{EBO}	$I_E = 10\mu A, I_C = 0$	5			V
	h _{FE1} *1	$V_{CE} = 10V, I_{C} = 150 \text{mA}^{*2}$	130		330	
Forward current transfer ratio	h _{FE2}	$V_{CE} = 5V, I_{C} = 500 \text{mA}^{*2}$	50	100		
Collector to emitter saturation voltage	V _{CE(sat)}	$I_C = 300 \text{mA}, I_B = 30 \text{mA}^{*2}$		0.2	0.4	V
Base to emitter saturation voltage	V _{BE(sat)}	$I_C = 300 \text{mA}, I_B = 30 \text{mA}^{*2}$		0.85	1.2	V
Transition frequency	f_T	$V_{CB} = 10V, I_E = -50mA, f = 100MHz$		120		MHz
Collector output capacitance	C _{ob}	$V_{CB} = 10V, I_E = 0, f = 1MHz$		11	20	pF

^{*2} Pulse measurement

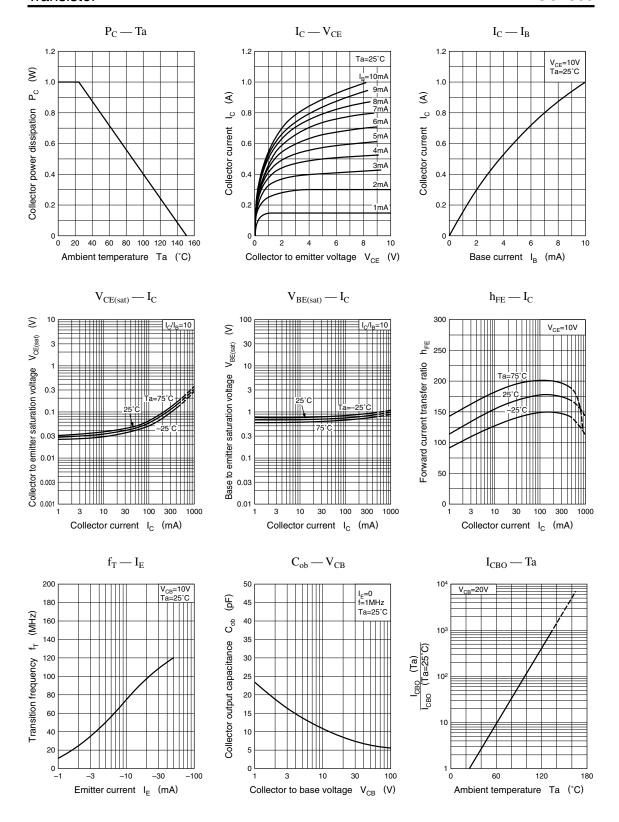
^{*1}hFE1 Rank classification

Rank	R	S
h _{FE1}	130 ~ 220	185 ~ 330

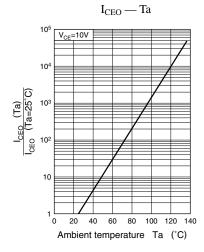
Note.) The Part number in the Parenthesis shows conventional part number.

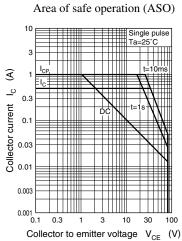
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Transistor 2SC1509



Transistor 2SC1509





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